

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**AMENDMENT "A" AND  
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

APPLICANT: Marcel Heerman

SERIAL NO.: 09/997,345

GROUP ART UNIT: 2811

DATE FILED: November 29, 2001

INVENTION: "AN INTERMEDIATE BASE FOR A SEMICONDUCTOR  
MODULE, A SEMICONDUCTOR MODULE USING  
THE INTERMEDIATE BASE AND A METHOD FOR  
PRODUCING THE INTERMEDIATE BASE"

Assistant Commissioner for Patents  
Washington, D.C. 20231

SIR:

Prior to examination, please amend the above-identified application as follows:

**IN THE SPECIFICATION:**

On page 5, please amend the paragraph starting at line 1 to read as follows:


A/ --A film composed of LCP (Liquid Crystal Polymer) or a material with similar  
thermal expansion characteristics is highly suitable for use as a material for the intermediate base.  
This material is described, for example, in an article in Advancing Microelectronics, July/August  
1998, pages 15-18.--

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 on January 15, 2002.

James D. Hobart

Name of Applicant's Attorney



Signature

January 15, 2002

Date

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